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High durability spring clips offer smartphone makers maximum cost savings with superb interconnect performance over a wide working range

Features and Benefits

Wide working range from 0.25 to 1.10mm (both series combined)	Offers greater design flexibility with specific loading control	
Anti-snag design (105386)	Prevents contact damage during assembly processing and yield loss	
Narrow clip width of 1.00mm (105386)	Supports small PCB applications	
1,500 durability cycles (105386)	Delivers sustained high performance	
Kinked ribs (105384)	Prevent solder wicking	
Device-to-PCB grounding contact	Reduces EMI noise and electrostatic discharge	
RF-to-PCB contact	Provides greater cost savings when used with non-soldered wire-less devices (example: antennas)	

Markets and Applications

Smartphone and Mobile Devices Consumer / Data / Telecom / Networking

- Digital cameras
- Digital video recorders
- Wireless LAN devices
- Set top boxes
- Small Office/Home Office (SOHO) switches and routers

Industrial

- Surveillance, security cameras and systems
- Point-Of-Sale (POS) scanners



Small Office/Home Office (SOHO) Switches and Routers



Smartphones and Tablets PCs



Security Camera



Low profile, high durability

105386 Reinforced, anti-snag design, 1.00mm width

105384 Kinked ribs, closed tip design, 2.00mm width



Reinforced, anti-snag spring clip, 1.00mm width (Series 105386)



Kinked ribs, closed tip spring clip, 2.00mm width (Series 105384)



GPS Devices

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Product Features

The reduced area on the dimple provides higher contact pressure between mated device and spring clip for enhanced contact reliability

Closed tip prevents accidental snagging of terminal during processing operations

Stopper features on both sides of the clip prevent excess deflection of the terminal when pushed from sideways

Gold plating on the mating contact improves both mechanical and electrical performance of the interconnect when mated (Series 105386)

Specifications

Reference Information

Packaging: Tape on reel Mates With: Electronic and RF devices depending on customer application **Designed In: Millimeters** RoHS: Yes Halogen Free: Yes Glow Wire Compliant: No

Electrical

Pick-and-place area for nozzle pre-load function

> Voltage (max.): 10 Volts DC Current (max.): 1.5 A (105386); 1.0A (105384) Low Level Contact Resistance (max.): 50 milliohm

Mechanical

Normal Force: 0.25N minimum before durability 0.20N minimum after durability Durability: 1500 cycles Vibration: 3.10G (RMS) between 20 to 500Hz, 15 minutes

Physical

Housing: None Contact: Stainless Steel Plating: Contact Area — Refer to table Soldering Area — $2\mu m$ (79 μ ") Gold (Au) (105386) Gold (Au) Flash (105384) Underplating — Nickel (Ni) overall Operating Temperature: -40 to +85°C

Ordering Information

Series No.	Contact Gold (Au) plating (µm, min.)	Working Range (mm)
<u>105386-0003</u>	0.25	
105386-0004	1.00	0.40 to 0.80
105384-0001	0.50	
<u>105384-0002</u>	0.50	0.70 to 1.10
<u>105384-0003</u>	0.50	0.25 to 0.50

www.molex.com/link/springclips.html

Spring Clips for Mobile Devices

The tip is closed to prevent nozzle pre-load function accidents during processing Kinked ribs on both sides of the clip

prevent solder-wicking

Pick-and-place area for

Stopper features prevent excess deflection of the clip

Anti-solder wicking and small solder area are hallmarks of this competitively priced

interconnect (Series 105384)